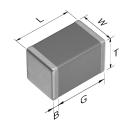
## 积层贴片陶瓷片式电容器

## C2012CH2A223K125AC

RoHS Reach Halogen Free Pb Free

交货型号	C2012CH2A223KT****
用途	一般等级
特点	Mid 中耐压(100~630V)
系列	C2012 [EIA 0805]
状态	金 量产体制(新设计非推荐) 推荐代替型号 : <u>C2012C0G2A223J125AC</u> (不保证其兼容性。)



尺寸		
长度(L)	2.00mm ±0.20mm	
宽度(W)	1.25mm ±0.20mm	
厚度(T)	1.25mm ±0.20mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.50mm Min.	
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)	
推存序益和向 (FA)	0.90mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)	
证书/杆皿:叩/叨 (t D)	0.70mm to 0.90mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)	
1世代/年益/中/四 U U/	0.90mm to 1.20mm(Reflow Soldering)	

电气特性		
电容	$22 nF \pm 10\%$	
额定电压	100VDC	
温度特性	CH (0 ± 60ppm/° C)	
Q (Min.)	1000	
绝缘电阻 (Min.)	10000ΜΩ	

	其他	
焊接方法	流体	
件按刀伍	回流	
AEC-Q200	NO	
包装形式	塑封编带 (180mm卷筒)	
包装个数	2000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

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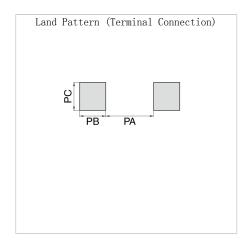
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## Associated Images



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